

# PNP Epitaxial Silicon Transistor

## BC556, BC557, BC558, BC559, BC560

### Features

- Switching and Amplifier
- High-Voltage: BC556,  $V_{CEO} = -65\text{ V}$
- Low-Noise: BC559, BC560
- Complement to BC546, BC547, BC548, BC549, and BC550
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector - Base Voltage BC556 BC557 / BC560 BC558 / BC559	$V_{CBO}$	-80 -50 -30	V
Collector - Emitter Voltage BC556 BC557 / BC560 BC558 / BC559	$V_{CEO}$	-65 -45 -30	V
Emitter - Base Voltage	$V_{EBO}$	-5	V
Collector Current (DC)	$I_C$	-100	mA
Peak Collector Current (Pulse)	$I_{CP}$	-200	mA
Peak Base Current (Pulse)	$I_{BP}$	-200	mA
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to +150	$^\circ\text{C}$

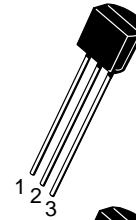
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS (Note 1)

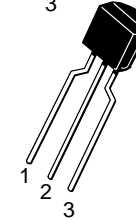
( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Max.	Unit
Total Device Dissipation Derate above $25^\circ\text{C}$	$P_D$	500 4.0	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	250	$^\circ\text{C}/\text{W}$

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.



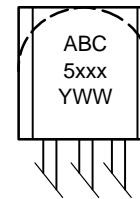
TO-92-3  
CASE 135AN  
Straight Lead  
Bulk Packing



TO-92-3  
CASE 135AR  
Bent Lead  
Tape & Reel  
Fan-Fold

1. Collector  
2. Base  
3. Emitter

### MARKING DIAGRAM



- A = Assembly Location  
BC5xxx = Specific Device Code  
xxx = 56A, 56B, 57A, 57B, 58B, 59B, 59C, 60C  
Y = Year  
WW = Work Week

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# BC556, BC557, BC558, BC559, BC560

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit	
I <sub>CBO</sub>	Collector Cut-Off Current	V <sub>CB</sub> = -30 V, I <sub>E</sub> = 0			-15	nA	
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -2 mA	110		800		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -10 mA, I <sub>B</sub> = -0.5 mA		-90	-300	mV	
		I <sub>C</sub> = -100 mA, I <sub>B</sub> = -5 mA		-250	-650		
V <sub>BE(sat)</sub>	Collector-Base Saturation Voltage	I <sub>C</sub> = -10 mA, I <sub>B</sub> = -0.5 mA		-700		mV	
		I <sub>C</sub> = -100 mA, I <sub>B</sub> = -5 mA		-900			
V <sub>BE(on)</sub>	Base-Emitter On Voltage	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -2 mA	-600	-660	-750	mV	
		V <sub>CE</sub> = -5 V, I <sub>C</sub> = -10 mA			-800		
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -10 mA, f = 10 MHz		150		MHz	
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0, f = 1 MHz			6	pF	
NF	Noise Figure	BC556 / BC557 / BC558	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -200 μA, f = 1 kHz, R <sub>G</sub> = 2 kΩ		2	10	dB
		BC559 / BC560			1	4	
		BC559	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -200 μA, R <sub>G</sub> = 2 kΩ, f = 30 to 15000 MHz		1.2	4.0	
		BC560			1.2	2.0	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## h<sub>FE</sub> CLASSIFICATION

Classification	A	B	C
h <sub>FE2</sub>	110 ~ 220	200 ~ 450	420 ~ 800

## ORDERING INFORMATION

Part Number	Marking	Package	Shipping†
BC556ABU	BC556A	TO-92-3, case 135AN (Pb-Free)	10,000 Units/ Bulk Box
BC556ATA	BC556A	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC556BTA	BC556B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC556BTF	BC556B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Tape & Reel
BC556BTFR	BC556B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Tape & Reel
BC557ATA	BC557A	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC557BTA	BC557B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC557BTF	BC557B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Tape & Reel
BC558BTA	BC558B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC559BTA	BC559B	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC559CTA	BC559C	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold
BC560CTA	BC560C	TO-92-3, case 135AR (Pb-Free)	2,000 Units/ Fan-Fold

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# BC556, BC557, BC558, BC559, BC560

## TYPICAL PERFORMANCE CHARACTERISTICS

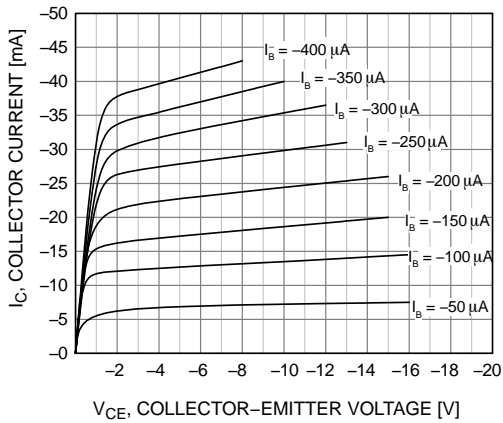


Figure 1. Static Characteristic

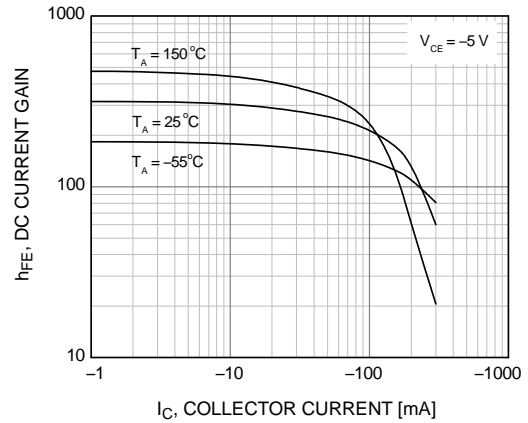


Figure 2. DC Current Gain

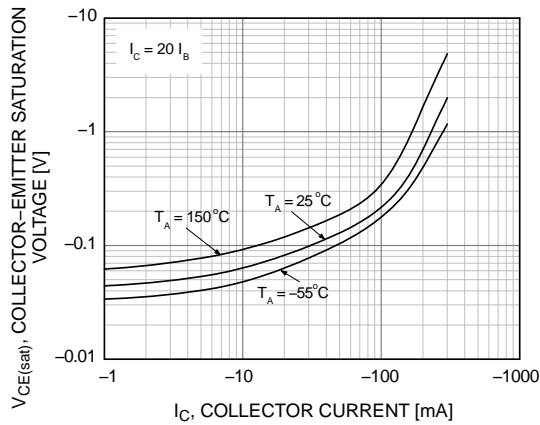


Figure 3. Collector-Emitter Saturation Voltage

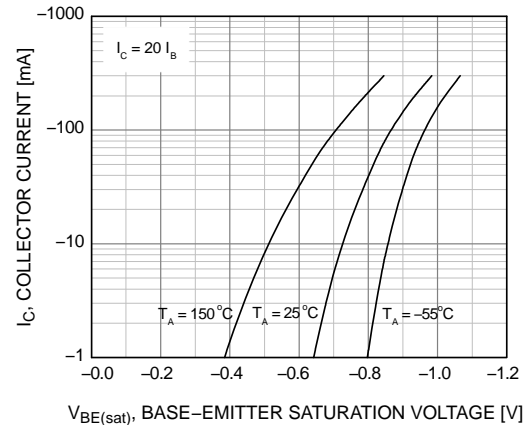


Figure 4. Base-Emitter Saturation Voltage

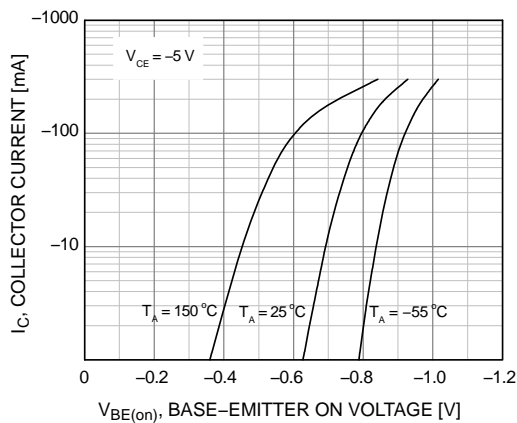


Figure 5. Base-Emitter On Voltage

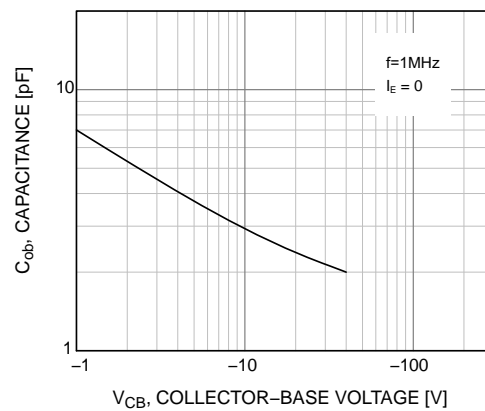
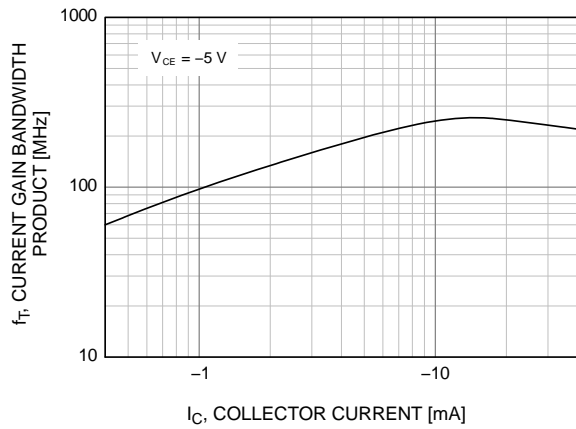


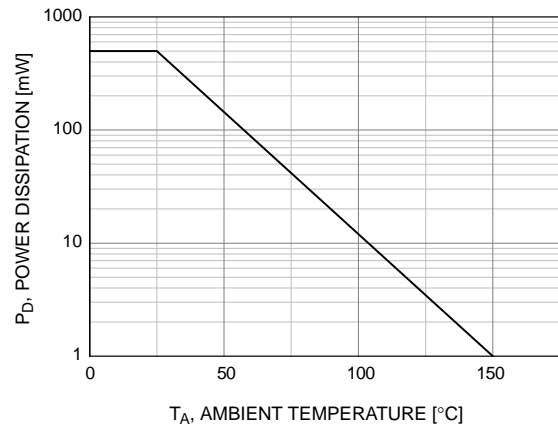
Figure 6. Collector Output Capacitance

# BC556, BC557, BC558, BC559, BC560

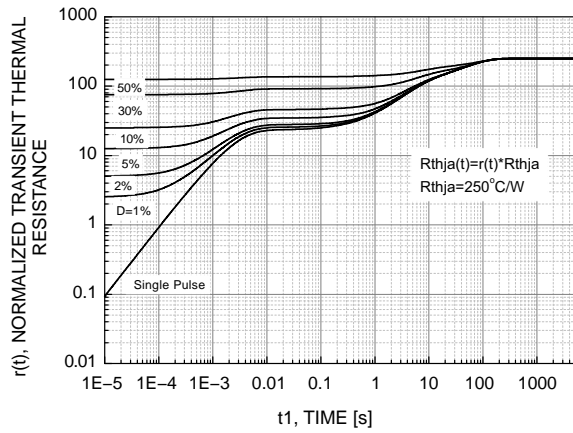
## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



**Figure 7. Current Gain Bandwidth Product**



**Figure 8. Power Deration**

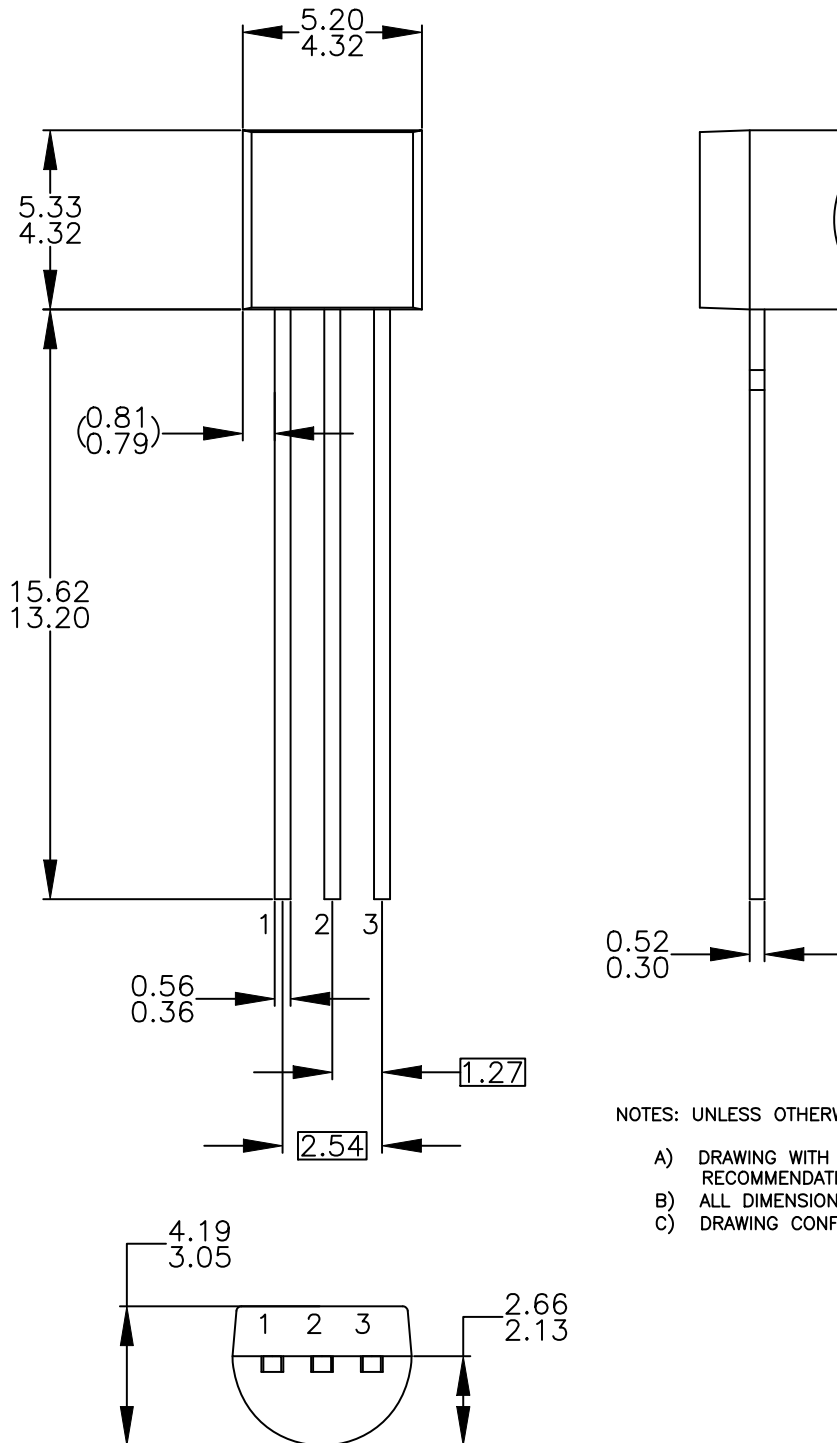


**Figure 9. Normalized Transient Thermal Resistance**

**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

TO-92 3 4.825x4.76  
CASE 135AN  
ISSUE O

DATE 31 JUL 2016



NOTES: UNLESS OTHERWISE SPECIFIED

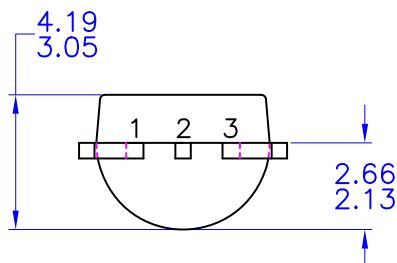
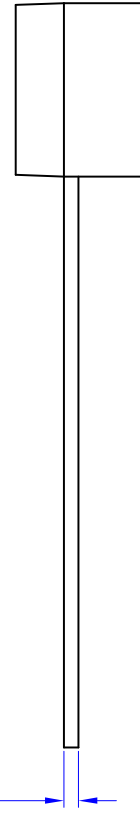
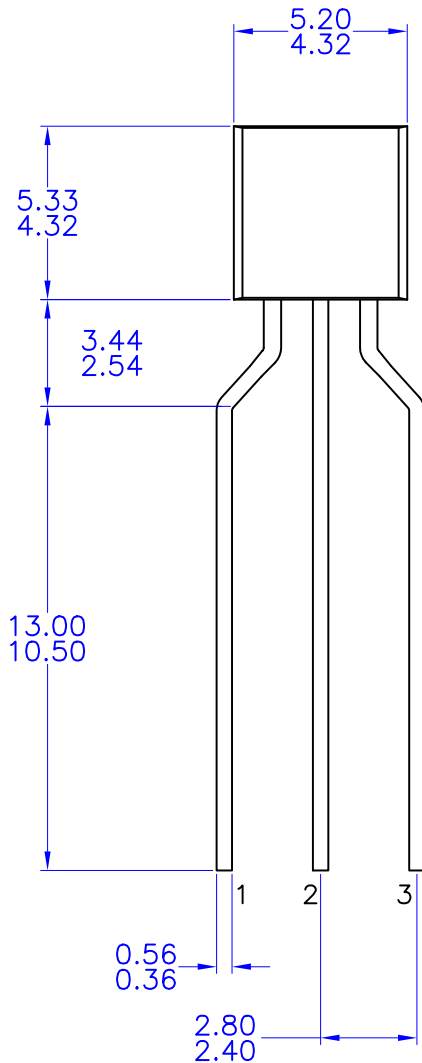
- A) DRAWING WITH REFERENCE TO JEDEC TO-92 RECOMMENDATIONS.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-2009.

<b>DOCUMENT NUMBER:</b>	<b>98AON13880G</b>	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
<b>DESCRIPTION:</b>	<b>TO-92 3 4.825X4.76</b>	<b>PAGE 1 OF 1</b>

ON Semiconductor and **ON** are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

**TO-92 3 4.83x4.76 LEADFORMED**  
**CASE 135AR**  
**ISSUE O**


DATE 30 SEP 2016



NOTES: UNLESS OTHERWISE SPECIFIED

- A) DRAWING WITH REFERENCE TO JEDEC TO-92 RECOMMENDATIONS.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-1994

<b>DOCUMENT NUMBER:</b>	<b>98AON13879G</b>	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
<b>DESCRIPTION:</b>	<b>TO-92 3 4.83X4.76 LEADFORMED</b>	<b>PAGE 1 OF 1</b>

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

**onsemi**, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Email Requests to: [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**onsemi Website:** [www.onsemi.com](http://www.onsemi.com)

### TECHNICAL SUPPORT

**North American Technical Support:**

Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

**Europe, Middle East and Africa Technical Support:**

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative